





2020 Research Day

System architecture and analysis of monolithic 3D-LiDAR based on CMOS Si Photomultiplier





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Research Motivation

- Photography is undergoing a paradigm shift to 3D Imaging
- Current 3D imaging approaches suffer from many draw-backs
- Novel devices and circuit designs implemented in CMOS technology are required to make 3D imaging a common-day reality
- Novel CMOS SPADs (Single Photon Avalanche Diode) arrays integrated into Si-Photomultipliers (SiPM) offer new opportunities by combining unprecedented performance in terms of photon counting as well as photon timing
- The key to a breakthrough in 3D imaging is understanding the physics of CMOS devices and the electro-optical requirements as well as ability to propose novel CMOS mixed design circuit implementation of new concepts
- The combination of new CMOS mixed circuit design architecture, CMOS physics and Electro-optics is where our strength, interest and unique capabilities can be best expressed

SiPM - Si Photomultiplier

- Array of mosaic sub-pixels SPADs electrically connected in parallel but responding individually at the speed of a single sub-pixel
- Each sub-pixel includes only a SPAD and quenching resistor
- Allows scaling down of sub-pixels

How many SiPM sub-pixels are required?

- In order to detect n random photons simultaneously, how many sub-pixels of **SPADS** are required?
- This is a key issue not reported before
- We evaluate the exact probability density for detection of a packet of random $m{n}$ photons, obeying Poisson Statistics, with a SiPM with *m* sub-pixels (of SPADs)

OPTIMIZING THE DESIGN OF SIPM ILLUSTRATED FOR ~700 PHOTONS



Conditional Probability density function

- Mixed design external output circuitry allows high fill factor
- Measures packets of photons not limited by dead-time
- Allows simultaneously photons counting/photon timing
- The most sensitive as well as fast solid state sensor



The limitation of Time-of-Flight

- The reflected radiation of the sun from the target provides background radiation
- Background photons contributed by the sun are just like signal photons, but are unwanted signals
- Since the background photon flux is typically high, $\sim 10^{12} [\text{ph}/\text{sec}]$, even with the narrow band filter operating at an optimal wavelength, the signal and background fluxes are typically of the same order of magnitude

- $n \sim Poisson(\lambda)$ photons randomly strike the SiPM matrix
- array consists of *m* identical sub-pixels
- $P(A_k)$ Probability for detecting k photons





LiDAR architecture and design

- SiPM, which consists of 1600 sub-pixels N+P SPADs with NIR sensitivity (PDE=0.15)
- Each sub-pixel contains only a quenching resistor $R_q = 300 K\Omega$ and AC coupled-capacitor $C_{ac} = 16 fF$
- 16 sub-SiPM, each sub-SiPM contains 100 SPADs





- The detector readout signal is a train of randomly distributed pulses corresponding to the detection of individual photons
- A signal photon and a background photon cannot be differentiated







The average value of the times is equal to $\overline{t} \equiv ToF = 666.5[ns]$ the estimated range is equal to $Z_d = \frac{c_0}{2}$ • *ToF*=99.975[m].



This work was reported at:

- 1. A. Eshkoli, A. Nemirovsky & Y. Nemirovsky (2019). Modeling the missing part of CMOS silicon photomultiplier;
- the ultimate photon counting and timing sensor. SPIE defense and commercial sensing, 2019, Baltimore, Maryland, US.
- A. Eshkoli and Y. Nemirovsky, "A stochastic approach for optimizing the required number of sub-pixels in 2.
- Silicon Photomultipiler (SiPM) for optical radar applications (LiDAR), 2018 IEEE International Conference on the Science of Electrical Engineering in Israel (ICSEE), Eilat, Israel, 2018, pp. 1-4.



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